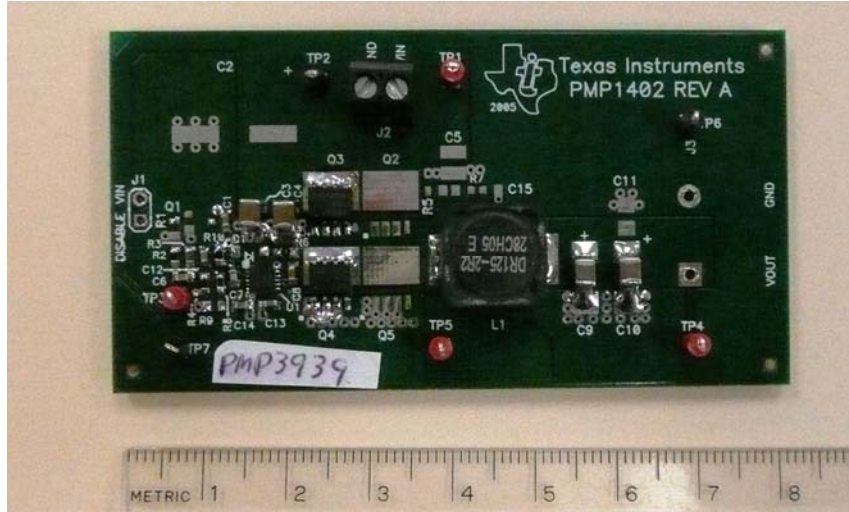


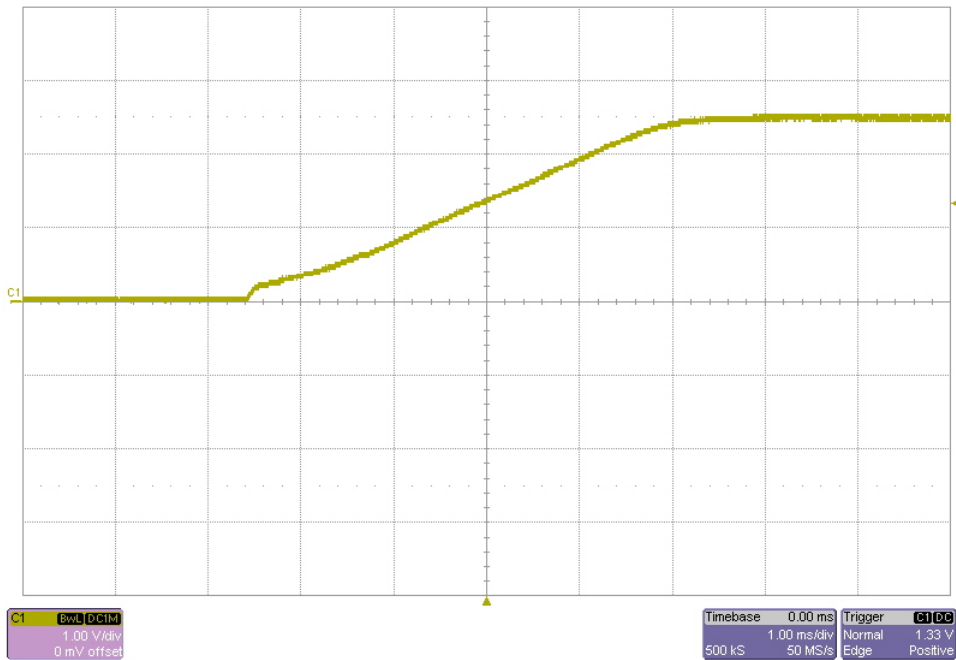
1 Photo

The photograph below shows the top view of the PMP3939 Rev B demo board. The circuit is built on a PMP1402 Rev A PWB.



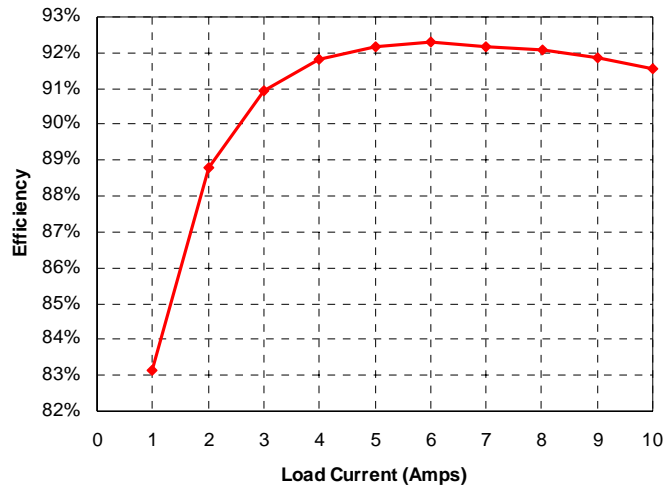
2 Startup

The output voltage at startup is shown in the image below.



3 Efficiency

The efficiency data is shown in the tables and graph below.



| Iout | Vout | Vin | Iin | Pout | Losses | Efficiency |
|-------|-------|------|-------|-------|--------|------------|
| 0.000 | 2.494 | 12.0 | 0.037 | 0.00 | 0.444 | 0.0% |
| 0.996 | 2.494 | 12.0 | 0.249 | 2.48 | 0.504 | 83.1% |
| 1.999 | 2.494 | 12.0 | 0.468 | 4.99 | 0.630 | 88.8% |
| 2.989 | 2.494 | 12.0 | 0.683 | 7.45 | 0.741 | 91.0% |
| 3.997 | 2.495 | 12.0 | 0.905 | 9.97 | 0.887 | 91.8% |
| 5.01 | 2.495 | 12.0 | 1.130 | 12.50 | 1.060 | 92.2% |
| 6.01 | 2.495 | 12.0 | 1.354 | 14.99 | 1.253 | 92.3% |
| 6.99 | 2.495 | 12.0 | 1.577 | 17.44 | 1.484 | 92.2% |
| 8.01 | 2.496 | 12.0 | 1.809 | 19.99 | 1.715 | 92.1% |
| 9.01 | 2.497 | 12.0 | 2.041 | 22.50 | 1.994 | 91.9% |
| 10.00 | 2.498 | 12.0 | 2.274 | 24.98 | 2.308 | 91.5% |

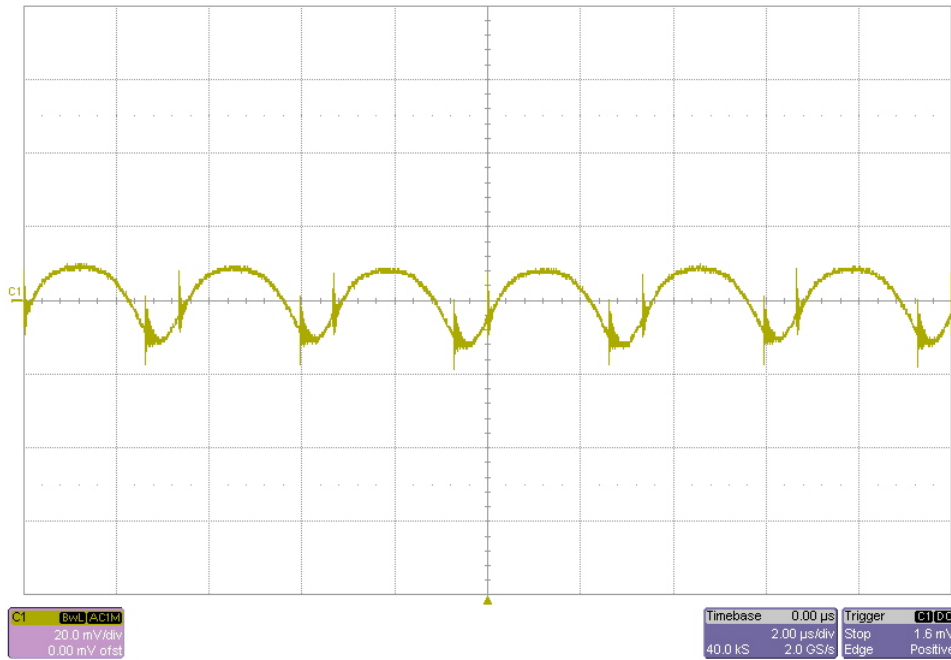
4 Thermal Image

A thermal image of the top side of the board is shown with a 10A load. The ambient temperature was 27°C, with no forced air flow. The bottom MOSFET (Q4) was the hottest component on the board and measured 62.6°C.



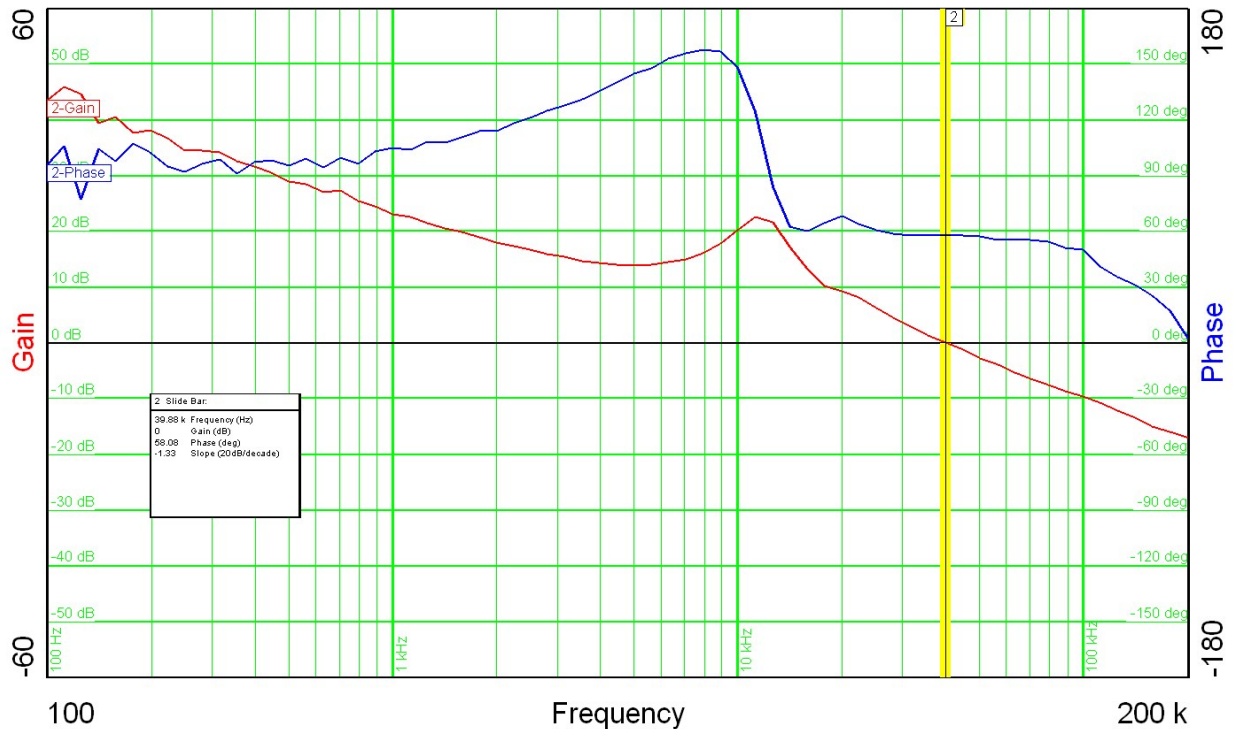
5 Output Ripple Voltage

The output ripple voltage is shown in the plot below. The input was set to 12V and the load was set to 10A.



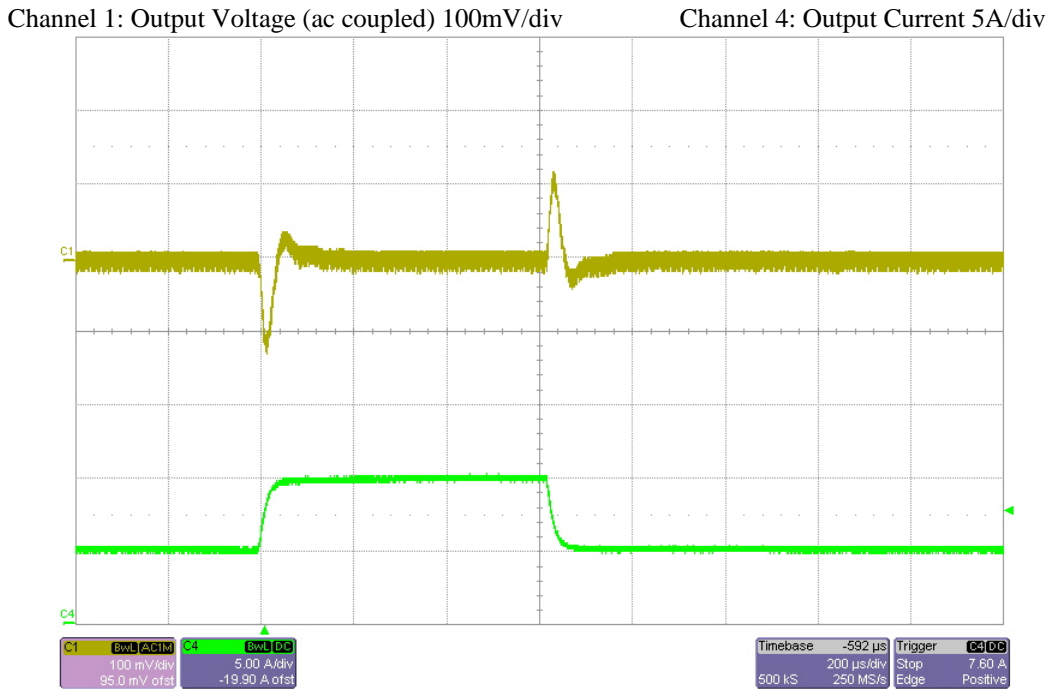
6 Frequency Response

The frequency response of the feedback loop is shown below. The input was set to 12V and the load was set to 10A.



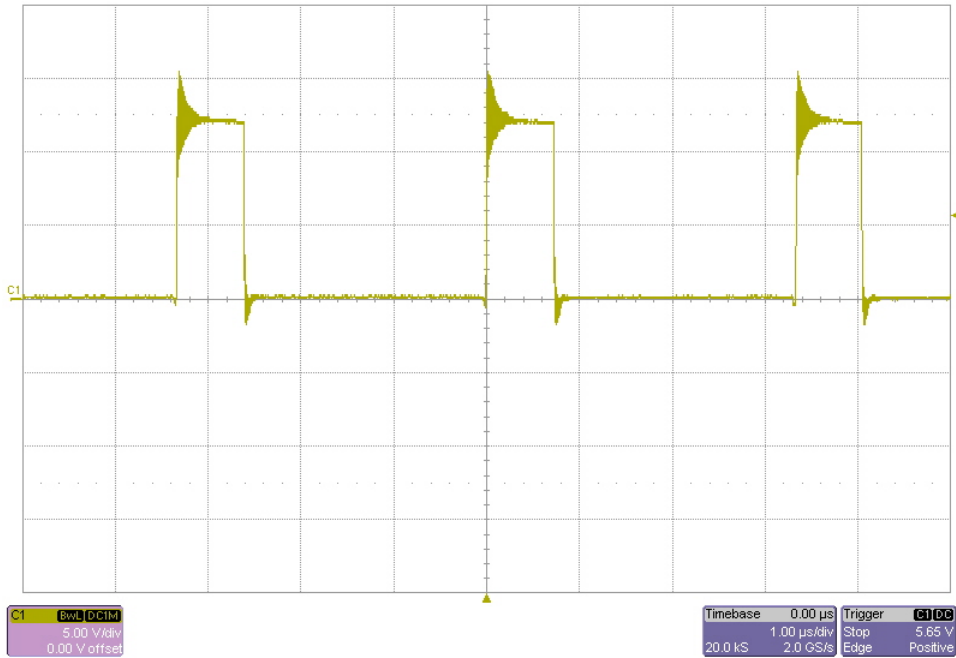
7 Load Transients

The image below shows the response to a 5A to 10A load transient with the input was set to 12V.



8 Switching Waveform

The image below shows the voltage on TP5 with a 10A load.



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